



Product Change Notification

111829 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

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Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 111829 - 00
Change Title: Intel® Integrated RAID Module
RMS25JB040, RMS25JB080, RMS25KB040
and RMS25KB080
PCN 111829-00, Product Design,
Documentation
Updating Processor Chip, Firmware and
Quick Start User's Guides
Date of Publication: November 1, 2012

Key Characteristics of the Change:
Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Dec 20, 2012
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Description of Change to the Customer:

The Intel® Integrated RAID Module RMS25KB080, RMS25KB040, RMS25JB080, and RMS25JB040 are being updated with D1 Stepping processor chip from B0 Stepping. This change allows for PCI Express* 3.0 functionality. In addition, its firmware version will be updated to 13.00.66.00 2012.10.09 to support the D1 stepping processor chip.

The Quick Start User's Guides for the Intel® Integrated RAID Module RMS25KB080, RMS25KB040 are being updated from G42745-002 to G42745-003 to include the latest information.

The Quick Start User's Guides for the Intel® Integrated RAID Module RMS25JB080, RMS25JB040 are being updated from G42743-001 to G42743-002 to include the latest information.

Customer Impact of Change and Recommended Action:

Intel recommends that the customer perform a standard level of evaluation as updated product become available.

Customers need to place future orders using the new Order Code (MM#) as noted in below table.

Products Affected / Intel Ordering Codes:

Product Code	Pre Change MM#	Pre Change TA	Pre Change PBA	Post Change MM#	Post Change TA	Post Change PBA
RMS25JB080	917087	G34900-302	G35851-302	924452	G34900-310	G35851-310
RMS25JB040	917088	G34901-302	G36714-302	924453	G34901-310	G36714-310
RMS25KB080	917089	G34902-302	G35828-302	924454	G34902-310	G35828-310
RMS25KB040	917090	G34903-302	G36694-302	924455	G34903-310	G36694-310

PCN Revision History:**Date of Revision:**

November 1, 2012

Revision Number:

00

Reason:

Originally Published PCN